



Charge losses close to the Si-SiO₂-interface^{*)}

1. Why study?
2. Measurement techniques
3. Results
4. Conclusions

***) work mainly done by T. Poehlsen + S.Schuwalow, Hamburg**

Why study?



1. **Impact on charge collection, charge sharing, charge memory**
 - enhanced charge collection time + increased plasma effect
→ signal spreading + losses + spill over to next XFEL bunch
2. **Stability of sensor performance (calibration!)**
 - surface conditions impact on device stability (breakdown, operation in vacuum and/or finite humidity)
 - stability of charge collection vs. time and operating conditions
 - stability of dark current, capacitances (noise) vs time
3. **Understand boundary conditions for simulations**

→ Is it a problem at all? and if yes

→ Is there a sensor design which avoids all that?

(NB. In my opinion an “old unresolved” problem of Si sensors which has caused malfunctioning of sensors in the past)

Measurement techniques



2.1 Sensors investigated:

- DC coupled strip sensor from Hamamatsu (50 μm pitch)
- AC coupled strip sensor from CIS (80 μm pitch) – for this sensor we have a good knowledge of several technological parameters

(both sensor have an overall passivation (apart from bonding windows))

→ **results similar** (only results of DC-sensor shown)

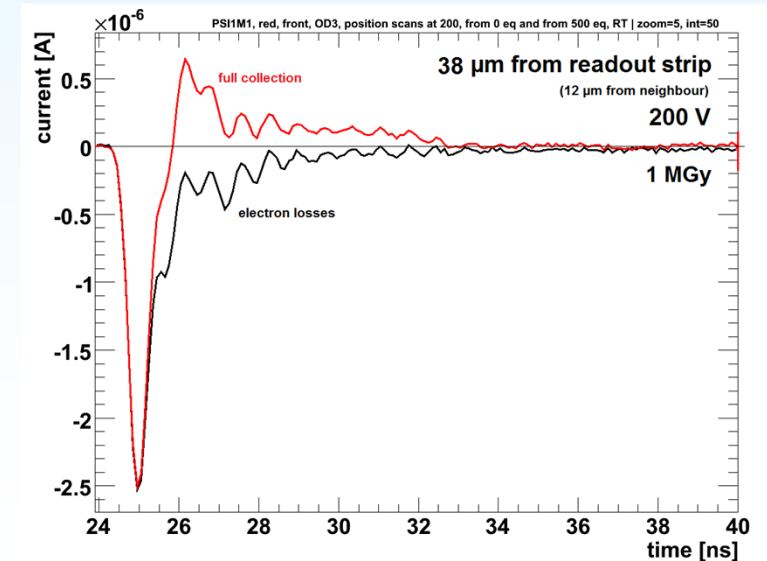
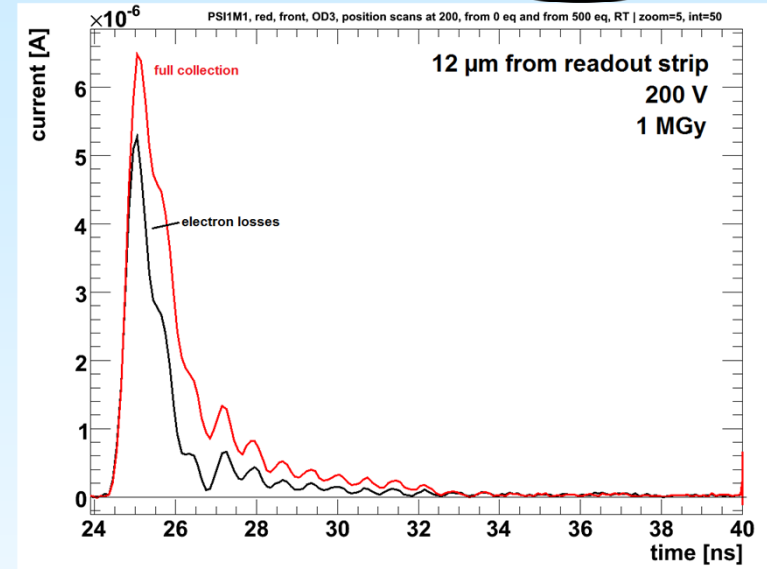
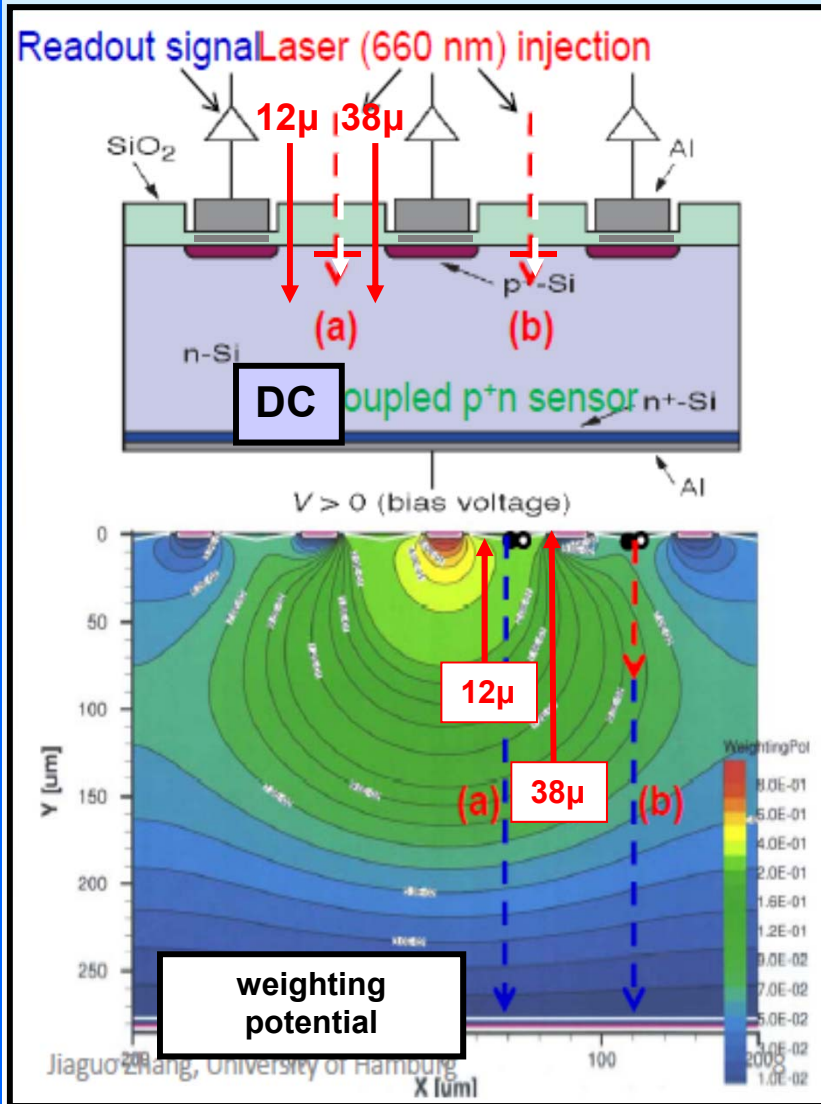
→ **independent of technology?**

Geometry parameters of DC- and AC-coupled strip sensors:

Parameter	DC-coupled strip sensor	AC-coupled strip sensor
Pitch	50 μm	80 μm
Gap	39 μm	60 μm
Width of implantation	11 μm	20 μm
Depth of implantation	-	1.2 μm
Metal overhang	2 μm	-2 μm
Number of strips	128	98
Length of strips	7956 μm	7800 μm
Thickness of sensor	450 μm	285 \pm 10 μm
Thickness of SiO ₂ /Si ₃ N ₄	334 nm	(200+50) nm & (300+50) nm
Thickness of passivation	1 μm	1 μm
Orientation	(1 1 1)	(1 0 0)

Measurement techniques

2.3 Pattern of electron losses

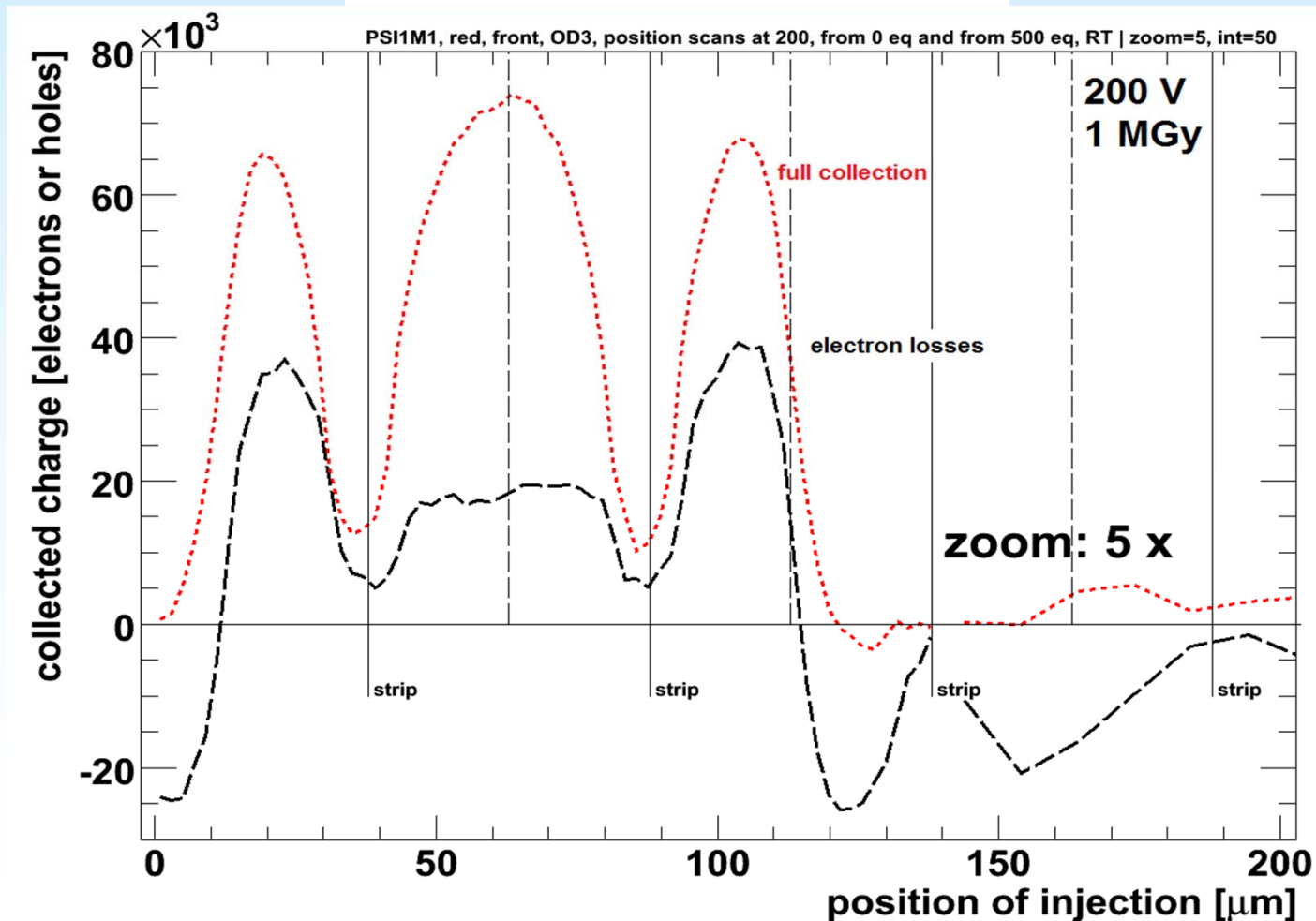


Measurement techniques

2.3 Pattern of electron losses

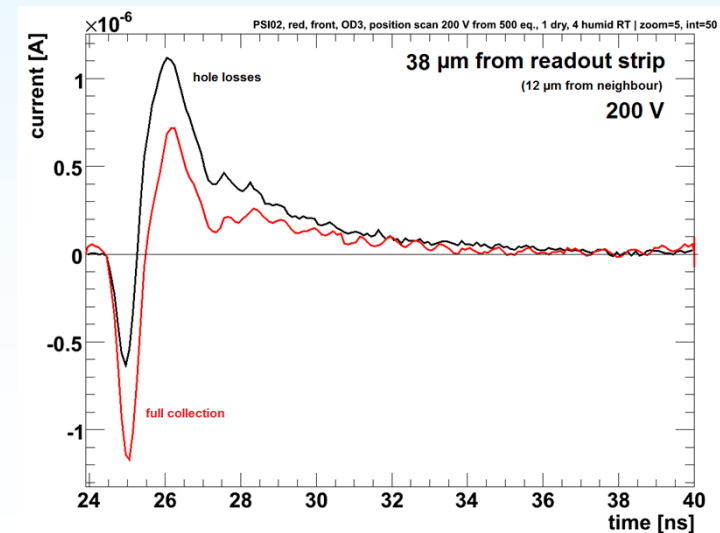
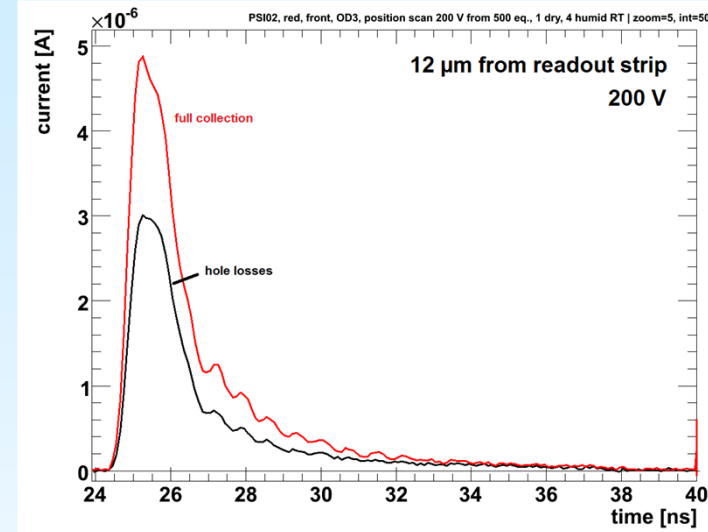
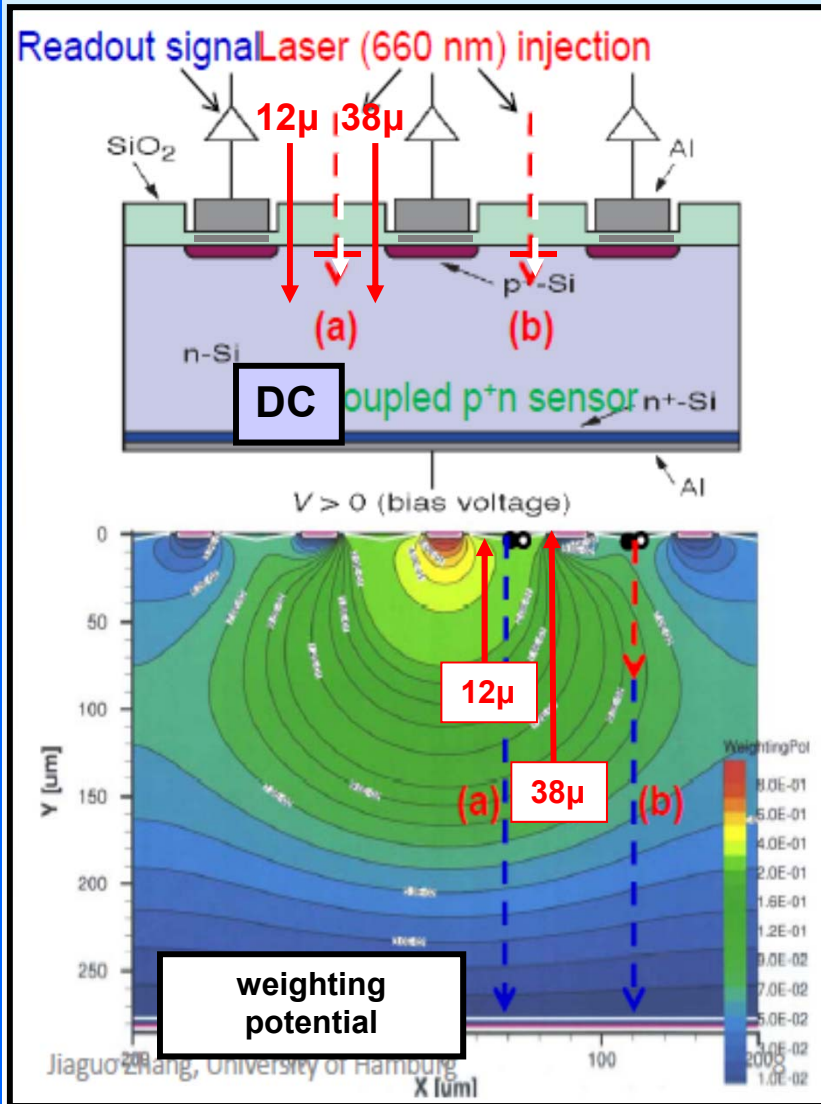


Sum of 2 strips (at 38 and 88 μm)



Measurement techniques

2.4 Pattern of hole losses

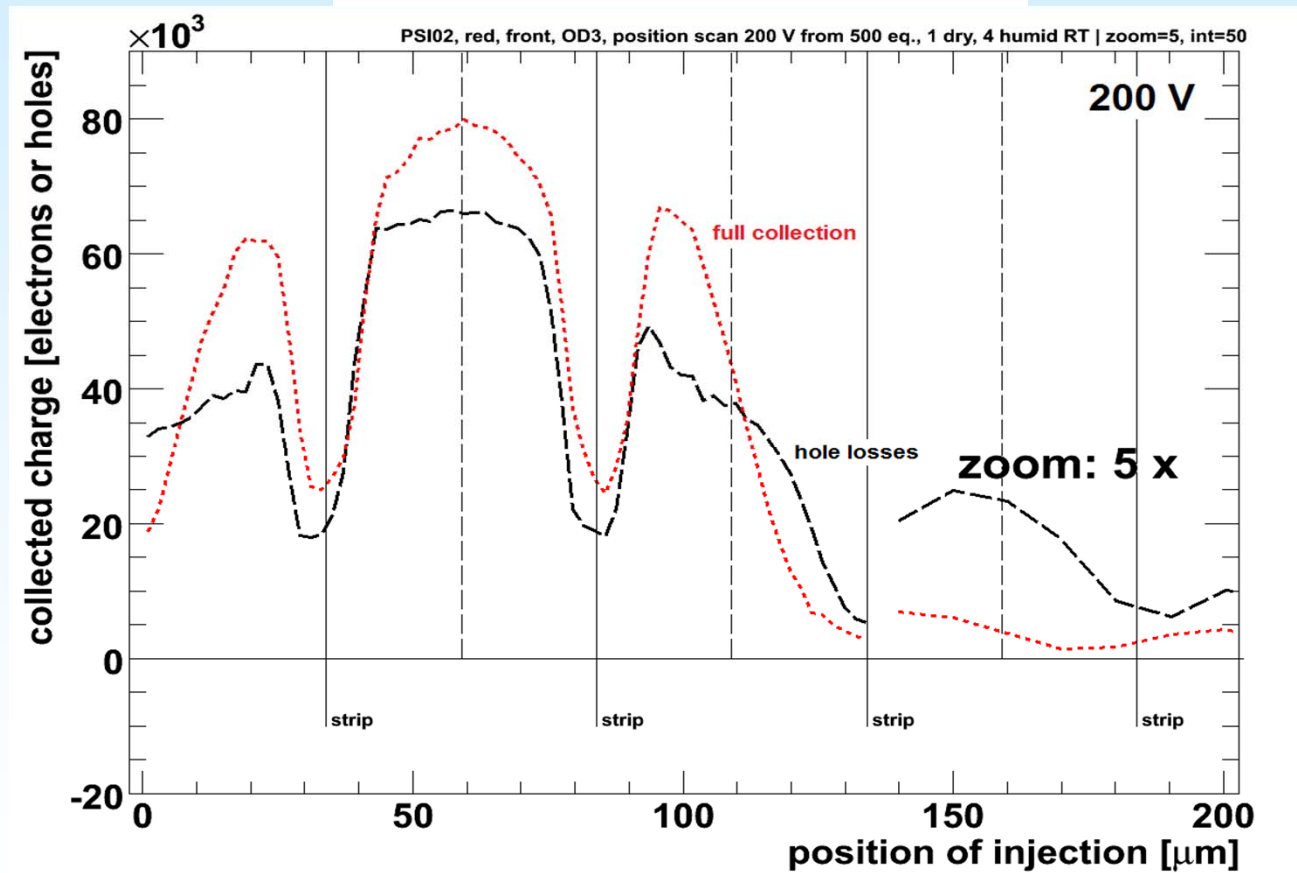


Measurement techniques



2.4 Pattern of hole losses

Sum of 2 strips (at 34 and 84 μm)



Results



3.1. Unirradiated sensor

“steady-state” if sensor for some time in “humid” conditions

V-ramp $\uparrow\downarrow$ in steady-state \rightarrow no losses

V-ramp \uparrow from steady-state at 0V under “dry” condition: electron losses

- 100 V	~ 60%
- 200 V	~ 40 %
- 300 V	~ 10 %
- 400 V	no losses observed
- 500 V	no losses observed

V-ramp \downarrow from steady-state at 500 V under “dry” condition: hole losses

- 100 V	~ 85%
- 200 V	~ 80 %
- 300 V	~ 75 %
- 400 V	~ 50%
- 500 V	no losses observed

- **stable** (> 1 day) conditions for “dry = N_2 ” conditions
- **change** (< 1 hour) to “steady-state” for “humid” conditions



Results

3.2. 1 MGy irradiated sensor

“steady-state” if sensor for some time in “humid” conditions

V-ramp $\uparrow\downarrow$ \rightarrow **electron losses**

- 100 V \sim 50% e-losses
- 200 V \sim 45% e-losses
- 300 V \sim 30% e-losses
- 400 V \sim 10% e-losses
- 500 V \sim 0% no losses

V-ramp \uparrow starting from **steady-state at 0 V “dry cond.”** \rightarrow **electron losses**

- 200 V \sim 90% e-losses
- 500 V \sim 80% e-losses
(stable for > 6 h)

V-ramp \downarrow starting from steady-state at 500 V “dry” \rightarrow **electron losses**

- 200 V \sim 0% losses at $t = 0$
 \sim 20% e-losses at $t = 6$ h

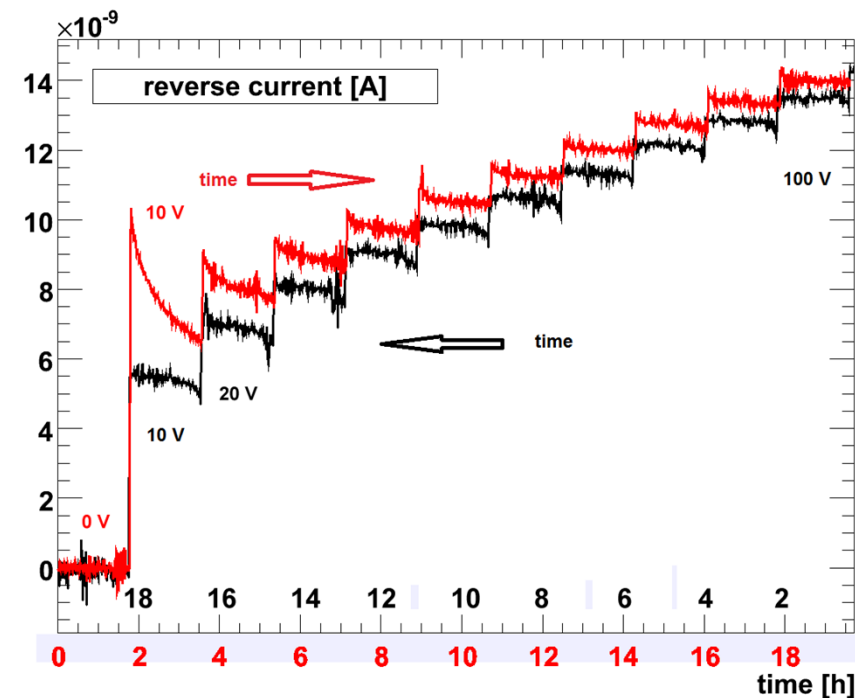
dark current (=surface current) also shows time dependence:

- V-ramp \uparrow

\rightarrow steady-state reached from above

- V-ramp \downarrow

\rightarrow steady-state reached from below





Conclusion

- **Measurements are reproducible !**
- **Similar results for sensors from 2 vendors**
- **Non-irradiated sensors:**
 - hole or electron losses, depending on direction of voltage ramping for “dry” conditions (stable over > 1day !)
 - no losses for “wet” conditions
- **Irradiated sensor:**
 - electron losses (NB up to 90 %!) for < 500 Volts
 - time dependence of current correlated with e-losses
- **Physics origin of effect unclear – in particular unclear how to simulate it (boundary conditions on top of oxide and at SiO₂-interface not clear)**
- **Still to understand impact on sensor performance at XFEL**
- **Impact of surface effects on max. operating voltage**
- **Does high conductive passivation stabilize sensors ?**